



# **GRF**2004 Broadband Gain Block 0.05 to 10 GHz

### FEATURES

- Flexible Bias Voltage and Current
- $\bullet$  Internally Matched to 50  $\Omega$
- Process: GaAs pHEMT
- Compact 1.5 x 1.5 mm DFN-6 Package

#### Reference: 5 V / 120 mA / 5.5 GHz

- Gain: 14.5 dB
- OIP3: 25.5 dBm
- OP1dB: 16 dBm
- Evaluation Board Noise Figure: 1.9 dB

### **APPLICATIONS**

- Microwave Backhaul
- C/X-Band Amplifier
- General Purpose Amplifier
- Instrumentation

### **DESCRIPTION**

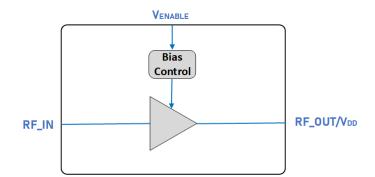
GRF2004 is a broadband, low-noise linear gain block designed for small cell, wireless infrastructure, and other high-performance RF applications. Due to the extreme broadband nature of the device, data is presented for wideband RF measurements using a Network Analyzer Bias-T. Under these conditions, the device exhibits good performance from 50 MHz to 10 GHz with minimal external components.

The device can be operated over a range of supply voltages from 1.8 to 5 V with selectable I<sub>DDQ</sub> for optimal efficiency and linearity.

Consult with the GRF applications engineering team for custom tuning/evaluation board data and device S-parameters.

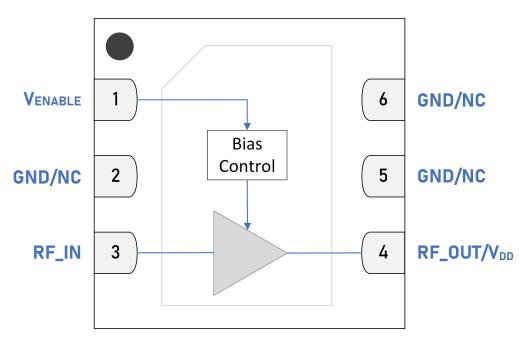
Additional tunes can be found on the GRF2004 "Custom Tunes" product page: <u>GRF2004 Custom Tunes</u>

### BLOCK DIAGRAM



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Pin Out (Top View)



# **Pin Assignments**

Pin	Name	Description	Note
1	V <sub>ENABLE</sub>	Enable Voltage Input	$V_{\text{ENABLE}}$ and series resistor set $I_{\text{DDQ}}$ . $V_{\text{ENABLE}}$ < 0.2 volts disables the device.
2, 5, 6	GND/NC	Ground or No Connect	No internal connection to die. We recommend connecting these pins to ground.
3	RF_IN	LNA RF Input	Internally matched to 50 $\Omega$ . An external DC blocking capacitor must be used.
4	RF_OUT/V <sub>DD</sub>	LNA RF Output	Internally matched to 50 $\Omega$ . V <sub>DD</sub> must be applied through an RF choke to this pin.
PKG BASE	GND	Ground	Provides DC and RF ground for LNA and thermal heat sink. Recommend multiple 8 mil vias beneath the package for optimal RF and thermal performance. Refer to the evaluation board top layer graphic on the schematic page.



# **Absolute Ratings**

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V <sub>DD</sub>	0	6	V
RF Input Power: Load VSWR < 2:1; $V_{DD}$ = 5 V.	P <sub>IN MAX</sub>		15	dBm
RF Input Power: Load VSWR < 2:1; $V_{DD} = < 4 V.$	P <sub>IN MAX</sub>		20	dBm
Operating Temperature (package base)	T <sub>PKG BASE</sub>	-40	105	°C
Maximum Channel Temperature (MTTF > 10 <sup>6</sup> hours)	T <sub>MAX</sub>		170	°C
Maximum Dissipated Power	P <sub>DISS MAX</sub>		600	mW

#### **Electrostatic Discharge**

Human Body Model	HBM	175		V	
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#### Storage

Storage Temperature	T <sub>STG</sub>	-65	150	°C
Moisture Sensitivity Level	MSL		1	



### **Caution! ESD Sensitive Device.**

**Exceeding Absolute Maximum Rating conditions may cause permanent damage.** 

Note: For additional information, please refer to Manufacturing Note MN-001 - Packaging and Manufacturing Information.



All Guerrilla RF products are provided in RoHS compliant lead (Pb)-free packaging. For additional information, please refer to the Certificate of RoHS Compliance.



# **Recommended Operating Conditions**

Parameter	Symbol	Specification			- Unit	Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Supply Voltage	V <sub>DD</sub>	0	5	6	V	
Operating Temperature (Package Base)	T <sub>PKG BASE</sub>	-40		105	°C	
RF Frequency Range	F <sub>RF</sub>	0.05		10	GHz	Typical application schematic using band-specific tunes (notes 1 & 2).
RF_IN Port Impedance	Z <sub>RFIN</sub>		50		Ω	Single-ended.
RF_OUT Port Impedance	Z <sub>RFOUT</sub>		50		Ω	Single-ended.

**Note 1:** Operation outside of this range is supported by using different custom tunes. Examples of other optimized tunes can be found here: <u>GRF2004 Custom Tunes</u>

**Note 2:** Contact the Guerrilla RF Applications team for guidance on optimizing the tuning of the device for alternative bands.



# **Nominal Operating Parameters - General**

The following conditions apply unless noted otherwise: typical application schematic using the 0.1 to 10 GHz tuning set,  $V_{DD}$  = 5 V,  $V_{ENABLE}$  = 5 V,  $I_{DD}$  = 120 mA,  $F_{TEST}$  = 5.5 GHz, 50  $\Omega$  system impedance,  $T_{PKG BASE}$  = 25 °C. Evaluation board losses are included within the specifications.

Parameter	Symbol	Specification			Unit	Condition	
Farameter	Symbol Min.		Тур.	Max.	Unit	Condition	
Switching Rise Time	T <sub>RISE</sub>		800		ns	Disabled mode to Gain mode <b>(note 3)</b> .	
Switching Fall Time	T <sub>FALL</sub>		600		ns	Gain mode to Disabled mode <b>(note 4)</b> .	
Supply Current	I <sub>DD</sub>		120		mA		
Enable Current	I <sub>ENABLE</sub>		1.8		mA		

#### **Disabled Mode**

Leakage Current	I <sub>LEAKAGE</sub>		1		μΑ	$V_{DD} = 5 V, V_{ENABLE} = 0 V.$	
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#### **Thermal Data**

Thermal Resistance (Infrared Scan)	Θ <sub>JC</sub>		104		°C/W	On standard evaluation board <b>(note 5)</b> .
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Note 3: Switching Time: 50% of  $V_{ENABLE}$  to 90% of  $P_{OUT}$ .

**Note 4:** Switching Time: 50% of VENABLE to 10% of P<sub>OUT</sub>.

**Note 5:** MTTF > 10<sup>6</sup> hours for  $T_{CHANNEL} \le 170$  °C.



# **Nominal Operating Parameters - RF**

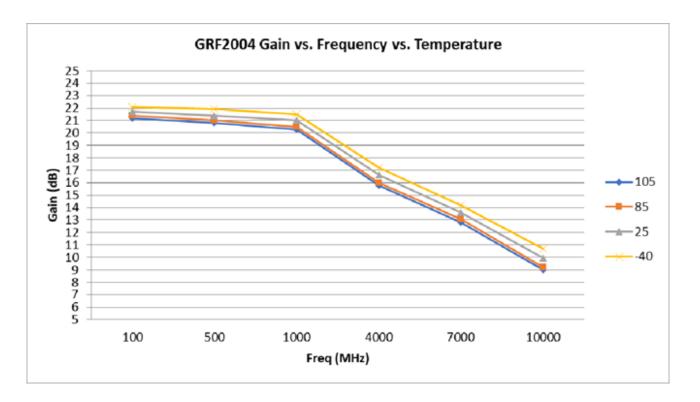
The following conditions apply unless noted otherwise: typical application schematic using the 0.1 to 10 GHz tuning set,  $V_{DD} = 5 \text{ V}$ ,  $V_{ENABLE} = 5 \text{ V}$ ,  $I_{DD} = 120 \text{ mA}$ ,  $F_{TEST} = 5.5 \text{ GHz}$ ,  $50 \Omega$  system impedance,  $T_{PKG BASE} = 25 \text{ °C}$ . Evaluation board losses are included within the specifications.

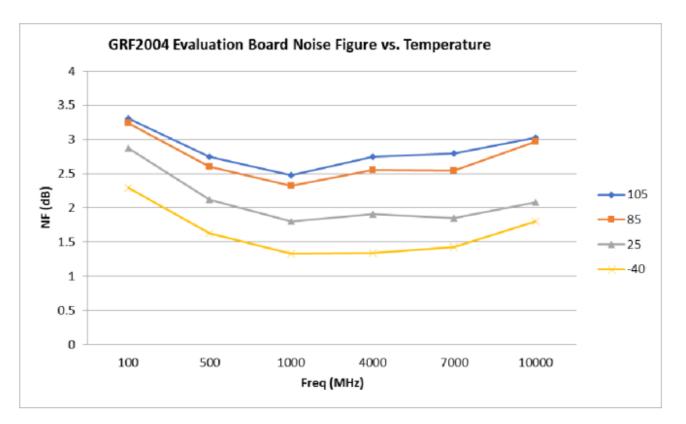
Parameter	Symbol	Specification			Unit	Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Small Signal Gain	S21	13.5	14.5		dB	
Reverse Isolation	S12		< -27		dB	
Noise Figure	NF		1.9		dB	On standard evaluation board.
Output 3rd Order Intercept Point	OIP3		25.5		dBm	0 dBm P <sub>OUT</sub> per tone at 2 MHz spacing.
Output 1 dB Compression Power	OP1dB	14.5	16		dBm	



RELEASE B DATA SHEET

# GRF2004 Typical Operating Curves: 5 V, 120 mA (0.1 to 10 GHz Tune)

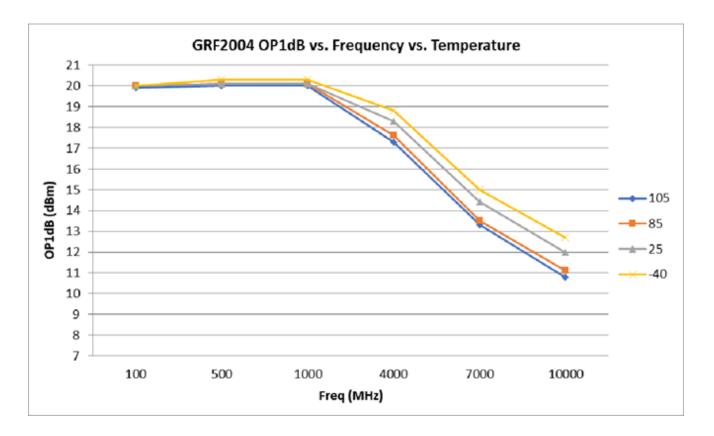


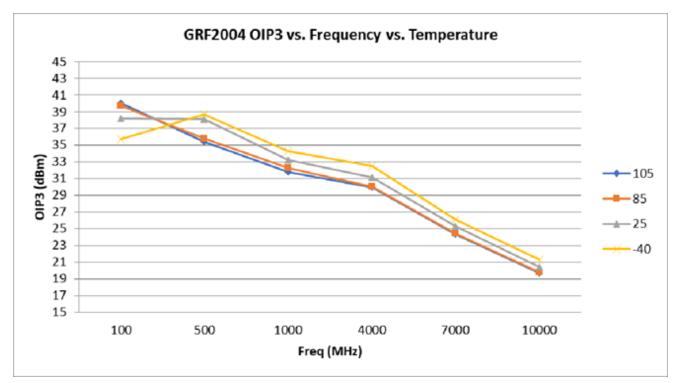




RELEASE B DATA SHEET

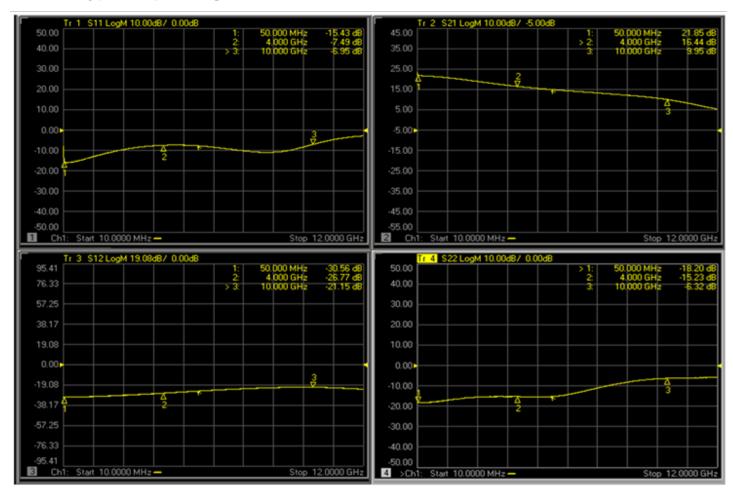
# GRF2004 Typical Operating Curves: 5 V, 120 mA (0.1 to 10 GHz Tune)







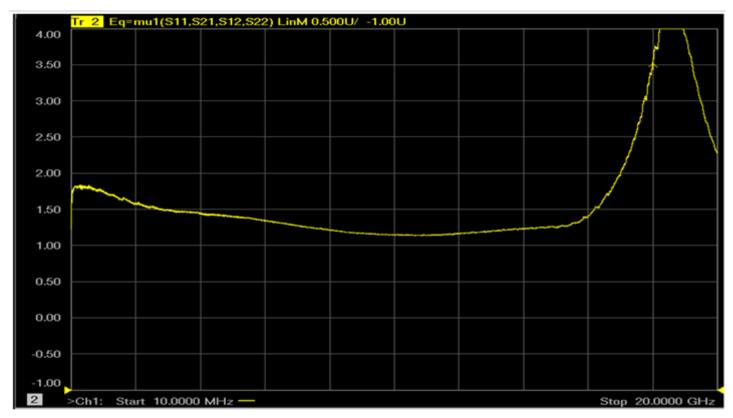
RELEASE B DATA SHEET



## **GRF2004** Typical Operating Curves: S-Parameters (0.05 to 10 GHz, VNA Bias-T)



RELEASE B DATA SHEET

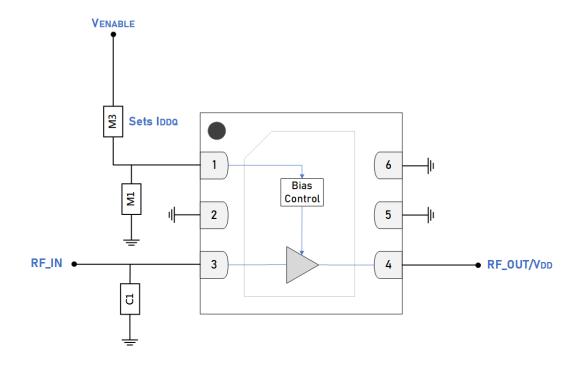


## **GRF2004** Typical Operating Curves: Stability Mu Factor (10 MHz to 20 GHz, VNA Bias-T)

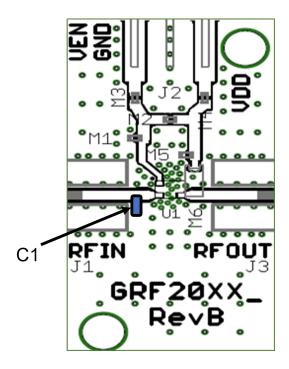
Note: Mu Factor ≥ 1.0 implies unconditional stability.



RELEASE B DATA SHEET



**GRF2004 Standard Evaluation Board Schematic** 



**GRF2004 Evaluation Board Assembly Diagram** 

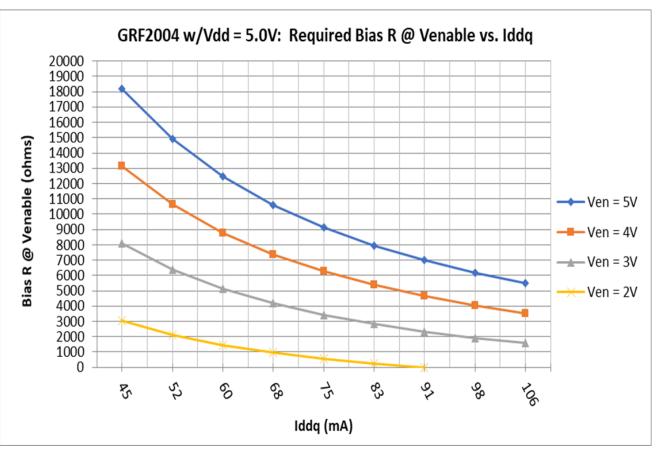


# **GRF2004 Evaluation Board Assembly Diagram Reference: 0.1 to 10 GHz Tune**

Component	Туре	Manufacturer	Family	Value	Package Size	Substitution
M1	Capacitor	Murata	GRM	1000 pF	0402	ok
M3	Resistor	Various	5%	6.0 kΩ	0402	ok
C1	Capacitor	Murata	GJM	0.2 pF	0402	ok
Evaluation Board	GRF20XX_RevB					

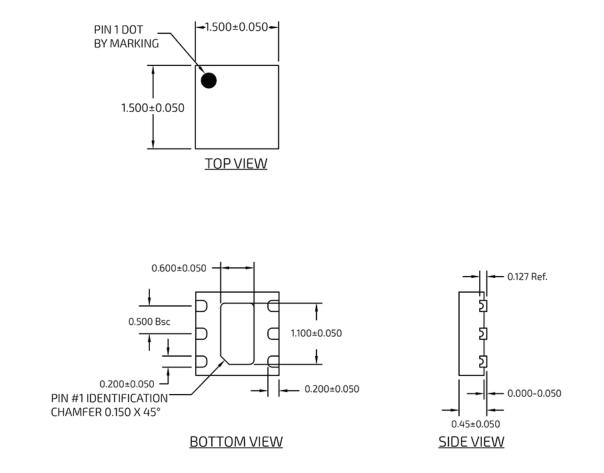
**Note:** C1 is added to evaluation board input to enhance high frequency gain of the device.

### **Bias Resistor Selection Curves:**



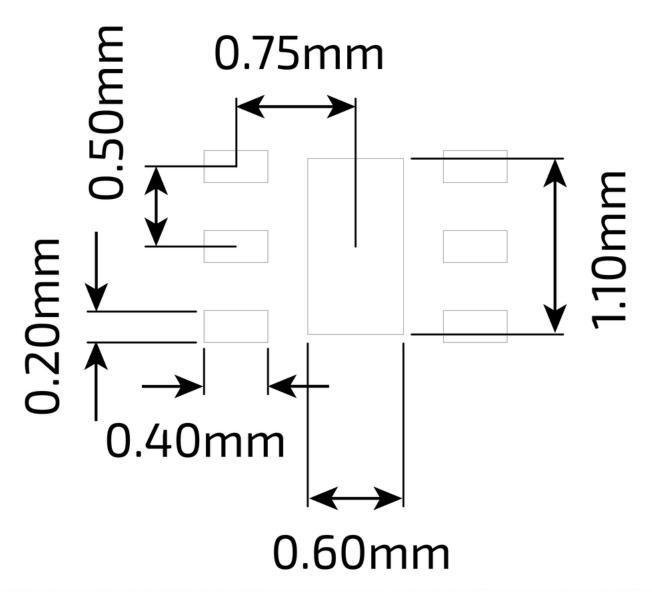


#### RELEASE B DATA SHEET



DFN 6 1.5x1.5mm Package Dimensions





DFN 6 1.5x1.5mm Suggested PCB Footprint (Top View)



RELEASE B DATA SHEET

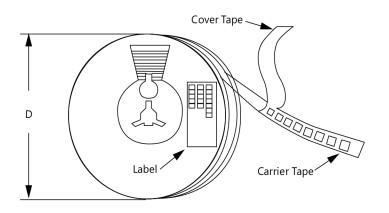
#### Package Marking Diagram



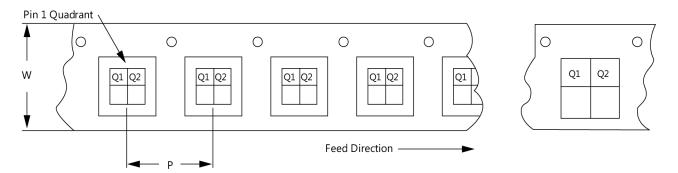
Line 1: "Y" = YEAR (single digit). "WW" = WORK WEEK the Device was assembled. Line 2: "XXXX" = Device Part Number.

#### **Tape and Reel Information**

Guerrilla RF's tape and reel specification complies with Electronics Industries Association (EIA) standards for "Embossed Carrier Tape of Surface Mount Components for Automatic Handling" (reference EIA-481). Devices are loaded with pins down into the carrier pocket with protective cover tape and reeled onto a plastic reel. Each reel is packaged in a cardboard box. There are product labels on the reel, the protective ESD bag, and the outside surface of the box. For the latest reel specifications and package information (including units/reel), please visit Package Manufacturing Information | Guerrilla RF (guerrilla-rf.com).



Tape and Reel Packaging with Reel Diameter Noted (D)



Carrier Tape Width (W), Pitch (P), Feed Direction and Pin 1 Quadrant Information



### RELEASE B DATA SHEET

### **Revision History**

<b>Revision Date</b>	Description of Change
December 14, 2017	Release A Data Sheet.
June 9, 2021	Upgraded Data Sheet to new format only.
February 14, 2022	Removed CDM parameter from Absolute Ratings.
July 26, 2024	Release B Data Sheet. Upgraded Data Sheet to newest format. Changed F <sub>TEST</sub> , I <sub>DD</sub> , Gain and OP1dB specifications to match PTP. Changed OIP3 specification to correlate with application's test data.
May 28, 2025	Extended lower frequency range from 100 MHz to 50 MHz.



#### RELEASE B DATA SHEET

#### **Data Sheet Classifications**

Data Sheet Status	Notes
Advance	S-parameter and NF data based on EM simulations for the fully packaged device using foundry-supplied transistor S-parameters. Linearity estimates based on device size, bias condition and experience with related devices.
Preliminary	All data based on evaluation board measurements taken within the Guerrilla RF Applications Lab. Any MIN/MAX limits represented within the data sheet are based solely on <i>estimated</i> part-to-part variations and process spreads. All parametric values are subject to change pending the collection of additional data.
Release Ø	All data based on measurements taken with <i>production-released</i> material. TYP values are based on a combination of ATE and bench-level measurements, with MIN/MAX limits defined using <i>modelled estimates</i> that account for part-to-part variations and expected process spreads. Although unlikely, future refinements to the TYP/MIN/MAX values may be in order as multiple lots are processed through the factory.
Release A-Z	All data based on measurements taken with production-released material <i>derived from multiple lots which have been fabricated over an extended period of time</i> . MIN/MAX limits may be refined over previous releases as more statistically significant data is collected to account for process spreads.

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